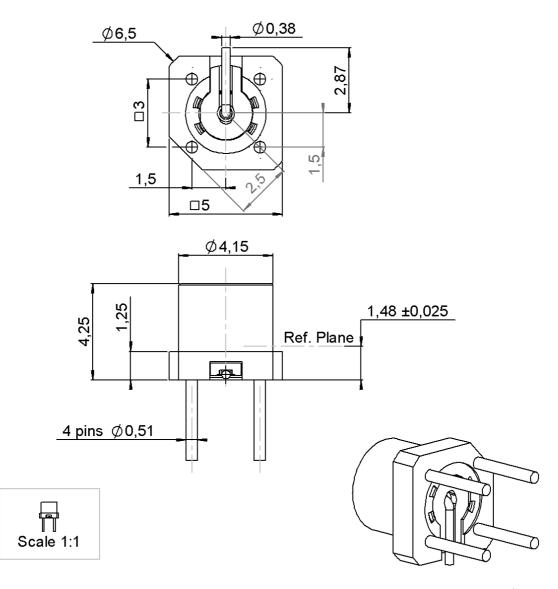
# R222.940.300

LIMITED DETENT-TAPE AND REEL BY 500

Series: **SMP-COM** 



All dimensions are in mm.

_	COMPONENTS	MATERIALS	PLATING (μm)
_	BODY CENTER CONTACT OUTER CONTACT INSULATOR GASKET OTHERS PARTS -	BRASS BRASS - PEEK - -	NPGR NPGR - -

**Issue:** 1121

In the effort to improve our products, we reserve the right to make changes judged to be



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### **PACKAGING**

# Standard Unit Other 500 Contact us

### **SPECIFICATION**

#### **ELECTRICAL CHARACTERISTICS**

Impedance  $50 \Omega$  Frequency 0-12.4\* GHz

Frequency **0-12.4\*** GHz VSWR **1.1\*\*** + **0,0000** x F(0)

VSWR 1.1\*\* + 0,0000 x F(GHz) Maxi Insertion loss 0.12  $\sqrt{F(GHz)}$  dB Maxi

RF leakage - ( NA - F(GHz)) dB Maxi Voltage rating 335 Veff Maxi

Dielectric withstanding voltage Insulation resistance 500 Veff mini 500 M $\Omega$  mini

### **ENVIRONMENTAL**

Operating temperature -55/+125 ° C

Hermetic seal NA Atm.cm3/s

Panel leakage NA

### **OTHER CHARACTERISTICS**

Assembly instruction NA

Others:

\* ROS 1.35 at 12.4Ghz

\*\*ROS at 6GHz

### **MECHANICAL CHARACTERISTICS**

Center contact retention

Axial force – Mating end
Axial force – Opposite end
Torque

6.8 N mini
NA N.cm mini

Recommended torque

Mating NA N.cm Panel nut NA N.cm

Mating life 100 Cycles mini

Weight **0,3610** g

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RADIALL®

## R222.940.300

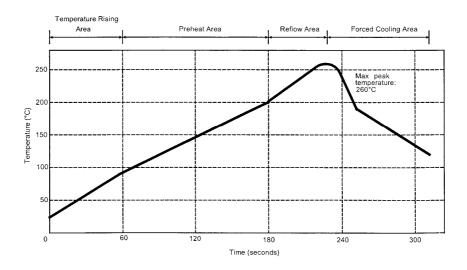
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#### **SOLDER PROCEDURE**

- 1. Deposit solder paste 'SnAg4Cu0.5' on mounting zone by screen printing application. We recommend a low residue flux.
  - We advise a thickness of 150 micromm (5.850 microinch). Verify that the edges of the zone are clean.
- 2. Placement of the receptacle on the mounting zone with an automatic machine of 'pick and place' type. A video camera is recommended for positioning of the component. Adhesive agents must not be used on the receptacle.
- 3. This process of soldering has been tested with convection oven .Below please find ,the typical profile to use.
- 4. The cleaning of printed circuit boards is not obliged .
- 5. Verification of solder joints and position of the component by visual inspection.

### **TEMPERATURE PROFILE**



Parameter	Value	Unit
Temperature rising Area	1 - 4	°C/sec
Max Peak Temperature	260	°C
Max dwell time @260°C	10	sec
Min dwell time @235°C	20	sec
Max dwell time @235°C	60	sec
Temperature drop in cooling Area	-1 to -4	°C/sec
Max dwell time above 100°C	420	sec

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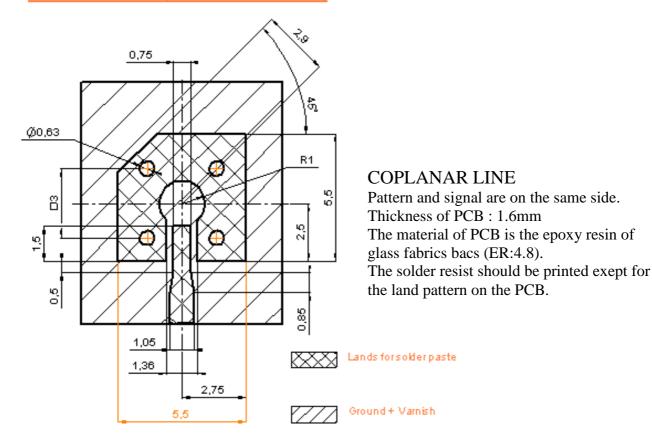


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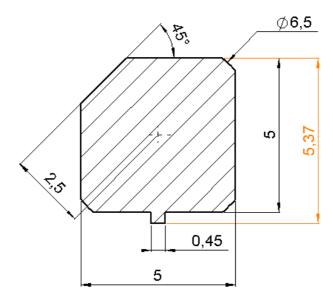
### LIMITED DETENT-TAPE AND REEL BY 500

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### STANDARD PAD(For ROGERS 4350)



### SHADOW OF RECEPTACLE FOR VIDEO CAMERA



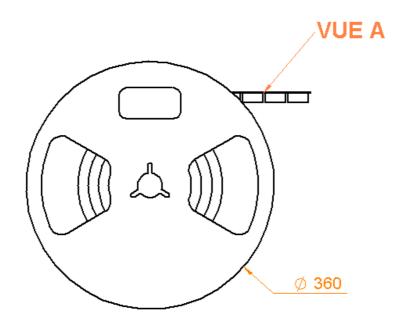
**Issue:** 1121 C In the effort to improve our products, we reserve the right to make changes judged to be necessary.

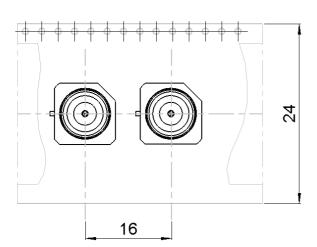


### LIMITED DETENT-TAPE AND REEL BY 500

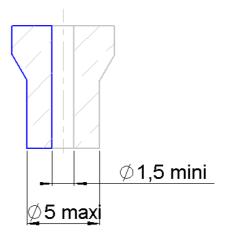
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### **AIR SUNCTION**



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